## WHAT IS CLAIMED IS:

- 1. A light emitting device comprising:
- a thin film transistor on an insulating surface;
- an interlayer insulating film over the thin film transistor;
- an anode over the interlayer insulating film;
- a wiring electrically connected to the thin film transistor and the anode;
- a bank over the wiring and the anode;
- a first insulating film over the anode and the bank;
- an organic compound layer over the anode with the first insulating film interposed therebetween; and
  - a cathode over the organic compound layer.
  - 2. A light emitting device comprising:
  - a thin film transistor on an insulating surface;
  - an interlayer insulating film over the thin film transistor;
  - an anode over the interlayer insulating film;
  - a wiring electrically connected to the thin film transistor and the anode;
  - a bank over the wiring and the anode;
  - a first insulating film over the anode and the bank;
- an organic compound layer over the anode with the first insulating film interposed therebetween; and
  - a cathode over the organic compound layer,
  - wherein the first insulating film is formed from an organic resin film.
  - 3. A light emitting device comprising:
  - a thin film transistor on an insulating surface;
  - an interlayer insulating film over the thin film transistor;
  - an anode over the interlayer insulating film;
  - a wiring electrically connected to the thin film transistor and the anode;
  - a bank over the wiring and the anode;
  - a first insulating film over the anode and the bank;
- an organic compound layer over the anode with the first insulating film interposed therebetween; and
  - a cathode over the organic compound layer,

wherein the first insulating film is at a film thickness of 1 to 5nm.

## 4. A light emitting device comprising:

- a thin film transistor on an insulating surface;
- an interlayer insulating film over the thin film transistor;
- an anode over the interlayer insulating film;
- a wiring electrically connected to the thin film transistor and the anode;
- a bank over the wiring and the anode;
- a first insulating film over the anode and the bank;
- an organic compound layer over the anode with the first insulating film interposed therebetween; and
  - a cathode over the organic compound layer.
  - wherein the bank is formed from an resin insulating film.

## 5. A light emitting device comprising:

- a thin film transistor on an insulating surface;
- an interlayer insulating film over the thin film transistor;
- an anode over the interlayer insulating film;
- a wiring electrically connected to the thin film transistor and the anode;
- a bank over the wiring and the anode;
- a first insulating film over the anode and the bank;
- an organic compound layer over the anode with the first insulating film interposed therebetween; and
  - a cathode over the organic compound layer.
  - wherein the anode is formed from indium thin oxide.

## 6. A light emitting device comprising:

- a thin film transistor on an insulating surface;
- an interlayer insulating film over the thin film transistor;
- an anode over the interlayer insulating film;
- a wiring electrically connected to the thin film transistor and the anode;
- a bank over the wiring and the anode;
- a first insulating film over the anode and the bank;
- an organic compound layer over the anode with the first insulating film interposed therebetween; and

a cathode over the organic compound layer. wherein the first insulating film is formed from an organic resin film; wherein the first insulating film is at a film thickness of 1 to 5nm; and wherein the anode is formed from indium thin oxide.

- 7. A device according to claim 1, wherein an average surface roughness (Ra) of the anode is in a range of 0.9 nm or less.
- 8. A device according to claim 1, wherein an average surface roughness (Ra) of the anode is in a range of 0.85 nm or less.
- 9. A device according to claim 1, wherein the interlayer insulating film comprises at least one selected from the group consisting of a silicon oxide film, a silicon nitride oxide film and a silicon oxide nitride film.
- 10. A device according to claim 1, wherein the bank is processed by a plasma; and wherein the bank comprises a hardened film including at least an element selected from the group consisting of hydrogen, nitrogen, halocarbon, hydrogen fluoride, and noble gas.
- 11. A device according to claim 1, wherein a second insulating film is formed over the interlayer insulating film; and wherein the second insulating film comprises at least one selected from the group consisting of a silicon nitride film and a diamond like carbon film.
  - 12. A device according to claim 1, wherein the light emitting device is in combination with an electric device; and wherein the electric device is one selected from the group consisting of a display, al still camera, a notebook type personal computer, a mobile computer, an image

a digital still camera, a notebook type personal computer, a mobile computer, an image reproduction apparatus including a recording medium, a goggle type display, a video camera and a mobile phone.

13. A device according to claim 2, wherein an average surface roughness (Ra) of the anode is in a range of 0.9 nm or less.

- 14. A device according to claim 2, wherein an average surface roughness (Ra) of the anode is in a range of 0.85 nm or less.
- 15. A device according to claim 2, wherein the interlayer insulating film comprises at least one selected from the group consisting of a silicon oxide film, a silicon nitride oxide film and a silicon oxide nitride film.
- 16. A device according to claim 2, wherein the bank is processed by a plasma; and wherein the bank comprises a hardened film including at least an element selected from the group consisting of hydrogen, nitrogen, halocarbon, hydrogen fluoride, and noble gas.
- 17. A device according to claim 2, wherein a second insulating film is formed over the interlayer insulating film; and wherein the second insulating film comprises at least one selected from the group consisting of a silicon nitride film and a diamond like carbon film.
- 18. A device according to claim 2, wherein the light emitting device is in combination with an electric device; and wherein the electric device is one selected from the group consisting of a display, a digital still camera, a notebook type personal computer, a mobile computer, an image reproduction apparatus including a recording medium, a goggle type display, a video camera and a mobile phone.
- 19. A device according to claim 3, wherein an average surface roughness (Ra) of the anode is in a range of 0.9 nm or less.
- 20. A device according to claim 3, wherein an average surface roughness (Ra) of the anode is in a range of 0.85 nm or less.
- 21. A device according to claim 3, wherein the interlayer insulating film comprises at least one selected from the group consisting of a silicon oxide film, a silicon nitride oxide film and a silicon oxide nitride film.

22. A device according to claim 3,

wherein the bank is processed by a plasma; and

wherein the bank comprises a hardened film including at least an element selected from the group consisting of hydrogen, nitrogen, halocarbon, hydrogen fluoride, and noble gas.

23. A device according to claim 3,

wherein a second insulating film is formed over the interlayer insulating film; and wherein the second insulating film comprises at least one selected from the group consisting of a silicon nitride film and a diamond like carbon film.

24. A device according to claim 3,

wherein the light emitting device is in combination with an electric device; and wherein the electric device is one selected from the group consisting of a display, a digital still camera, a notebook type personal computer, a mobile computer, an image reproduction apparatus including a recording medium, a goggle type display, a video camera and a mobile phone.

- 25. A device according to claim 4, wherein an average surface roughness (Ra) of the anode is in a range of 0.9 nm or less.
- 26. A device according to claim 4, wherein an average surface roughness (Ra) of the anode is in a range of 0.85 nm or less.
- 27. A device according to claim 4, wherein the interlayer insulating film comprises at least one selected from the group consisting of a silicon oxide film, a silicon nitride oxide film and a silicon oxide nitride film.
  - 28. A device according to claim 4,

wherein the bank is processed by a plasma; and

wherein the bank comprises a hardened film including at least an element selected from the group consisting of hydrogen, nitrogen, halocarbon, hydrogen fluoride, and noble gas.

29. A device according to claim 4,

wherein a second insulating film is formed over the interlayer insulating film; and wherein the second insulating film comprises at least one selected from the group consisting of a silicon nitride film and a diamond like carbon film.

30. A device according to claim 4,

wherein the light emitting device is in combination with an electric device; and wherein the electric device is one selected from the group consisting of a display, a digital still camera, a notebook type personal computer, a mobile computer, an image reproduction apparatus including a recording medium, a goggle type display, a video camera and a mobile phone.

- 31. A device according to claim 5, wherein an average surface roughness (Ra) of the anode is in a range of 0.9 nm or less.
- 32. A device according to claim 5, wherein an average surface roughness (Ra) of the anode is in a range of 0.85 nm or less.
- 33. A device according to claim 5, wherein the interlayer insulating film comprises at least one selected from the group consisting of a silicon oxide film, a silicon nitride oxide film and a silicon oxide nitride film.
  - 34. A device according to claim 5,

wherein the bank is processed by a plasma; and

wherein the bank comprises a hardened film including at least an element selected from the group consisting of hydrogen, nitrogen, halocarbon, hydrogen fluoride, and noble gas.

35. A device according to claim 5,

wherein a second insulating film is formed over the interlayer insulating film; and wherein the second insulating film comprises at least one selected from the group consisting of a silicon nitride film and a diamond like carbon film.

36. A device according to claim 5,

wherein the light emitting device is in combination with an electric device; and

wherein the electric device is one selected from the group consisting of a display, a digital still camera, a notebook type personal computer, a mobile computer, an image reproduction apparatus including a recording medium, a goggle type display, a video camera and a mobile phone.

- 37. A device according to claim 6, wherein an average surface roughness (Ra) of the anode is in a range of 0.9 nm or less.
- 38. A device according to claim 6, wherein an average surface roughness (Ra) of the anode is in a range of 0.85 nm or less.
- 39. A device according to claim 6, wherein the interlayer insulating film comprises at least one selected from the group consisting of a silicon oxide film, a silicon nitride oxide film and a silicon oxide nitride film.
- 40. A device according to claim 6,
  wherein the bank is processed by a plasma; and
  wherein the bank comprises a hardened film including at least an element
  selected from the group consisting of hydrogen, nitrogen, halocarbon, hydrogen
  fluoride, and noble gas.
- 41. A device according to claim 6, wherein a second insulating film is formed over the interlayer insulating film; and wherein the second insulating film comprises at least one selected from the group consisting of a silicon nitride film and a diamond like carbon film.
- 42. A device according to claim 6, wherein the light emitting device is in combination with an electric device; and wherein the electric device is one selected from the group consisting of a display, a digital still camera, a notebook type personal computer, a mobile computer, an image reproduction apparatus including a recording medium, a goggle type display, a video camera and a mobile phone.